

Electronic Patent Application Fee Transmittal				
Application Number:		10551460		
Filing Date:		30-Sep-2005		
Title of Invention:		THERMOPLASTIC RESIN SHEET AND LAMINATE		
First Named Inventor/Applicant Name:		Masaki Matsudo		
Filer:		Lee Cheng/Conlee Tercenio		
Attorney Docket Number:		MIY-0207		
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U.S. National Stage under 35 USC 371 Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
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Utility Appl issue fee	1501	1	1510	1510
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Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
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Printed copy of patent - no color	8001	3	3	9
Total in USD (\$)				1819